Electronic Patent Application Fee Transmittal							
Application Number:	105	10598717					
Filing Date:	08-Sep-2006						
Title of Invention:	Pol	Polishing pad and semiconductor device manufacturing method					
First Named Inventor/Applicant Name:	Tetsuo Shimomura						
Filer:	Daniel E. Altman/Hiroko Isetani						
Attorney Docket Number:	UNIU40.017APC						
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U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
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Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Request for continued examination	1801	1	810	810
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